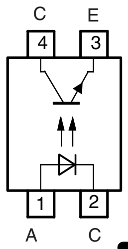
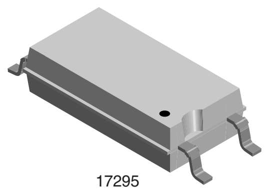
Optocoupler, Phototransistor Output, SOP-6L4, 110 °C Rated, Long Mini-Flat Package





DESCRIPTION

The TCLT1010 series consists of a phototransistor optically coupled to a gallium arsenide infrared-emitting diode in a 4-lead SOP-6L package.
The elements are mounted on one leadframe providing a fixed distance between input and output for highest safety requirements.

FEATURES

- SMD low profile 4 lead package
- High isolation 5000 V_{RMS}
- CTR flexibility available see order information
- Special construction
- Extra low coupling capacitance
- Connected base
- DC input with transistor output
- Temperature range - 40 °C to 110 °C
- Thickness through insulation ≥ 0.75 mm
- Creepage distance > 8 mm
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

APPLICATIONS

- Switchmode power supplies
- Computer peripheral interface
- Microprocessor system interface

AGENCY APPROVALS

- UL1577, file no. E76222 system code W, double protection
- CUL - file no. E52744, equivalent to CSA bulletin 5A
- DIN EN 60747-5-2 (VDE 0884)

ORDER INFORMATION	
PART	**REMARKS**
TCLT1010	CTR 50 to 600 %, SOP-6L4
TCLT1012	CTR 63 to 125 %, SOP-6L4
TCLT1013	CTR 100 to 200 %, SOP-6L4
TCLT1014	CTR 160 to 320 %, SOP-6L4
TCLT1015	CTR 50 to 150 %, SOP-6L4
TCLT1016	CTR 100 to 300 %, SOP-6L4
TCLT1017	CTR 80 to 160 %, SOP-6L4
TCLT1018	CTR 130 to 260 %, SOP-6L4
TCLT1019	CTR 200 to 400 %, SOP-6L4

Note
Available only on tape and reel.

ABSOLUTE MAXIMUM RATINGS [1]				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Reverse voltage		V_R	6	V
Forward current		I_F	60	mA
Forward surge current	$t_P \le 10$ µs	I_{FSM}	1.5	A
Power dissipation		P_{diss}	100	mW
Junction temperature		T_j	125	°C
OUTPUT				
Collector emitter voltage		V_{CEO}	70	V
Emitter collector voltage		V_{ECO}	7	V
Collector current		I_C	50	mA
Collector peak current	$t_P/T = 0.5$, $t_P \le 10$ ms	I_{CM}	100	mA
Power dissipation		P_{diss}	150	mW
Junction temperature		T_j	125	°C
COUPLER				
Isolation test voltage (RMS)		V_{ISO}	5000	V_{RMS}
Total power dissipation		P_{tot}	250	mW
Operating ambient temperature range		T_{amb}	- 40 to + 110	°C
Storage temperature range		T_{stg}	- 40 to + 110	°C
Soldering temperature [2]		T_{sld}	260	°C

Notes

[1] T_{amb} = 25 °C, unless otherwise specified.
Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

[2] Refer to reflow profile for soldering conditions for surface mounted devices.

ELECTRICAL CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	I_F = 50 mA	V_F		1.25	1.6	V
Junction capacitance	V_R = 0 V, f = 1 MHz	C_j		50		pF
OUTPUT						
Collector emitter voltage	I_C = 1 mA	V_{CEO}	70			V
Emitter collector voltage	I_E = 100 µA	V_{ECO}	7			V
Collector emitter cut-off current	V_{CE} = 20 V, I_F = 0 A, E = 0	I_{CEO}		10	100	nA
COUPLER						
Collector emitter saturation voltage	I_F = 10 mA, I_C = 1 mA	V_{CEsat}			0.3	V
Cut-off frequency	V_{CE} = 5 V, I_F = 10 mA, R_L = 100 Ω	f_c		110		kHz
Coupling capacitance	f = 1 MHz	C_k		0.3		pF

Note

T_{amb} = 25 °C, unless otherwise specified.
Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
I_C/I_F	V_{CE} = 5 V, I_F = 5 mA	TCLT1010	CTR	50		600	%
	V_{CE} = 5 V, I_F = 10 mA	TCLT1012	CTR	63		125	%
		TCLT1013	CTR	100		200	%
	V_{CE} = 5 V, I_F = 1 mA	TCLT1012	CTR	22	45		%
		TCLT1013	CTR	34	70		%
		TCLT1014	CTR	56	100		%
	V_{CE} = 5 V, I_F = 5 mA	TCLT1015	CTR	50		150	%
		TCLT1016	CTR	100		300	%
		TCLT1017	CTR	80		160	%
		TCLT1018	CTR	130		260	%
		TCLT1019	CTR	200		400	%

MAXIMUM SAFETY RATINGS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward current		I_F			130	mA
OUTPUT						
Power dissipation		P_{diss}			265	mW
COUPLER						
Rated impulse voltage		V_{IOTM}			8	kV
Safety temperature		T_{si}			150	°C

Note

According to DIN EN 60747-5-2 (VDE 0884)/DIN EN 60747-5-5 pending (see figure 1). This optocoupler is suitable for safe electrical isolation only within the safety ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.

INSULATION RATED PARAMETERS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Partial discharge test voltage - routine test	100 %, t_{test} = 1 s	V_{pd}	1.6			kV
Partial discharge test voltage - lot test (sample test)	t_{Tr} = 60 s, t_{test} = 10 s, (see figure 2)	V_{IOTM}	8			kV
		V_{pd}	1.3			kV
Insulation resistance	V_{IO} = 500 V	R_{IO}	10^{12}			Ω
	V_{IO} = 500 V, T_{amb} = 100 °C	R_{IO}	10^{11}			Ω
	V_{IO} = 500 V, T_{amb} = 150 °C (construction test only)	R_{IO}	10^{9}			Ω

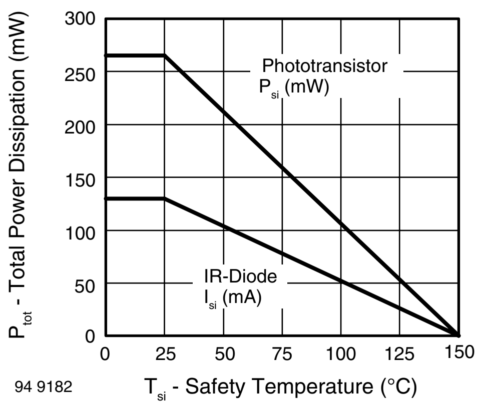


Fig. 1 - Derating Diagram

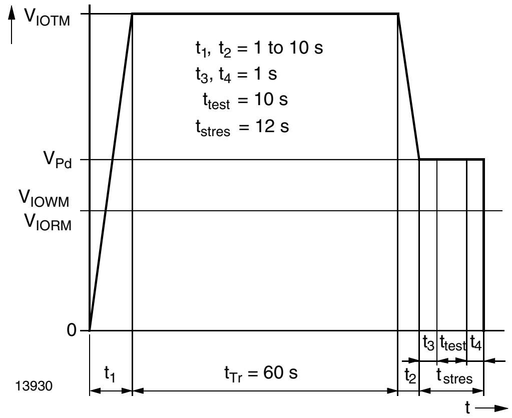


Fig. 2 - Test Pulse Diagram for Sample Test According to DIN EN 60747-5-2 (VDE 0884)/DIN EN 60747-; IEC60747

SWITCHING CHARACTERISTICS						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Delay time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω, (see figure 3)	t_d		3		µs
Rise time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω, (see figure 3)	t_r		3		µs
Fall time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω, (see figure 3)	t_f		4.7		µs
Storage time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω, (see figure 3)	t_s		0.3		µs
Turn-on time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω, (see figure 3)	t_{on}		6		µs
Turn-off time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω, (see figure 3)	t_{off}		5		µs
Turn-on time	V_S = 5 V, I_F = 10 mA, R_L = 1 kΩ, (see figure 4)	t_{on}		9		µs
Turn-off time	V_S = 5 V, I_F = 10 mA, R_L = 1 kΩ, (see figure 4)	t_{off}		10		µs

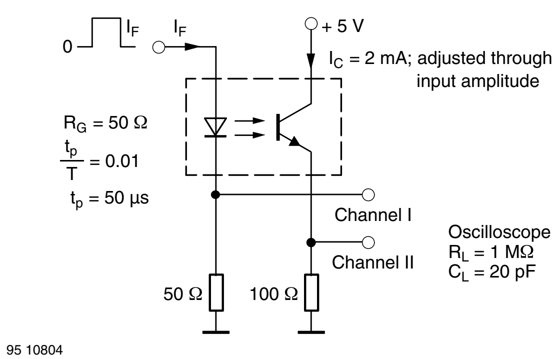


Fig. 3 - Test Circuit, Non-Saturated Operation

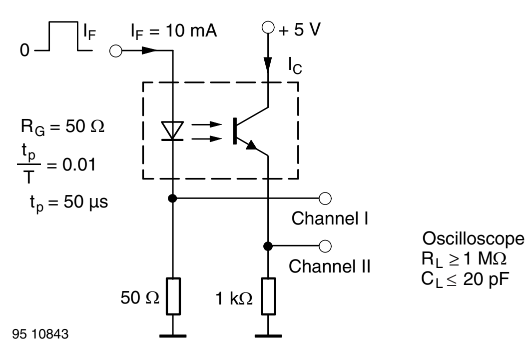


Fig. 4 - Test Circuit, Saturated Operation

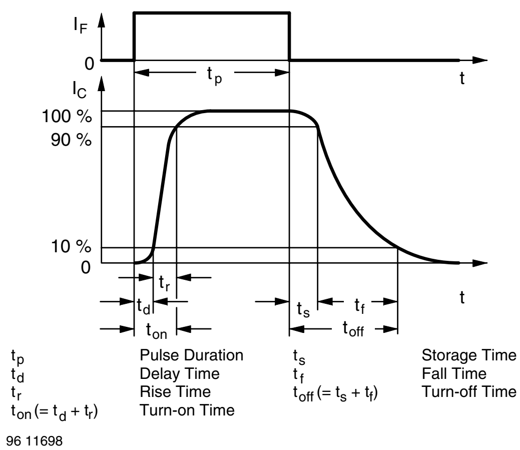


Fig. 5 - Switching Times

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

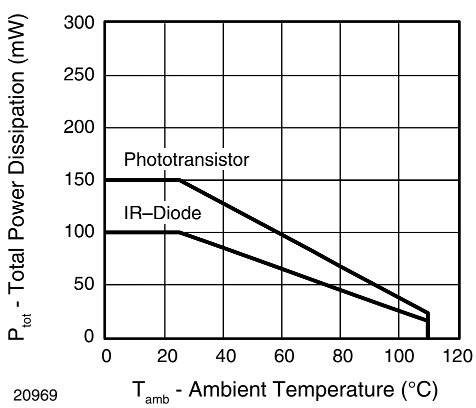


Fig. 6 - Total Power Dissipation vs. Ambient Temperature

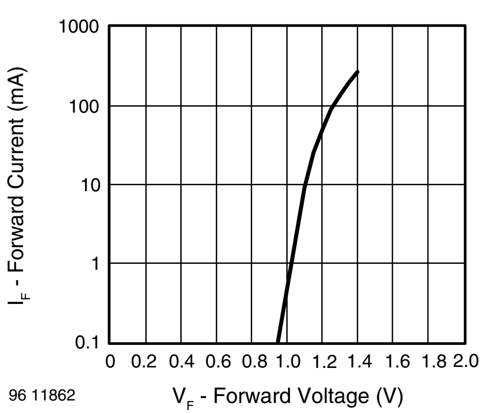


Fig. 7 - Forward Current vs. Forward Voltage

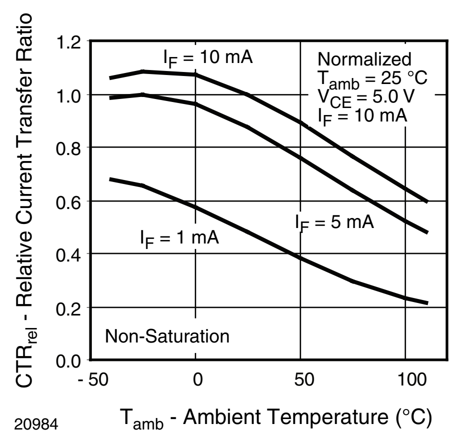


Fig. 8 - Relative Current Transfer Ratio vs. Ambient Temperature

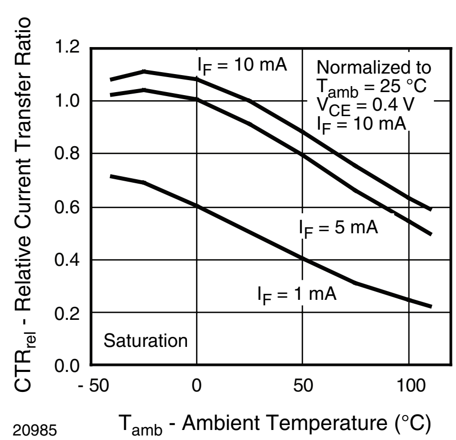


Fig. 9 - Relative Current Transfer Ratio vs. Ambient Temperature

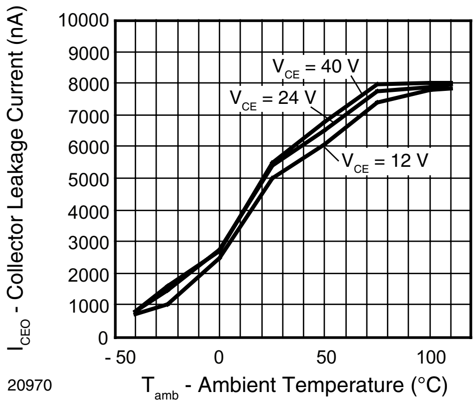


Fig. 10 - Collector Leakage Current vs. Ambient Temperature

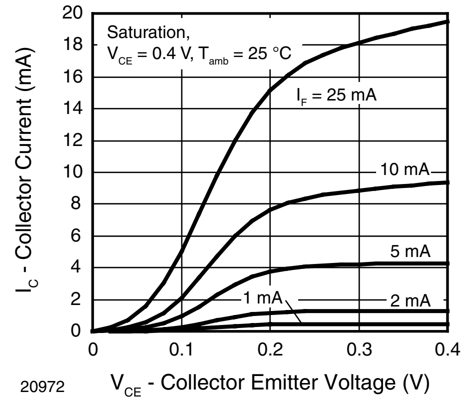


Fig. 13 - Collector Current vs. Collector Emitter Voltage

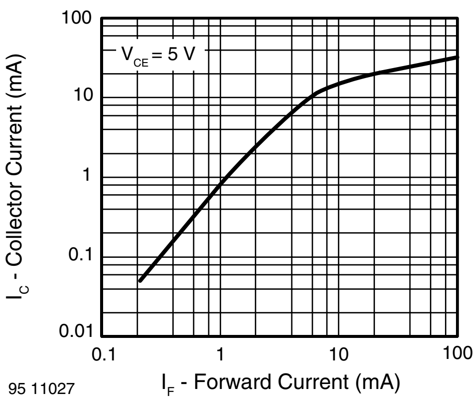


Fig. 11 - Collector Current vs. Forward Current

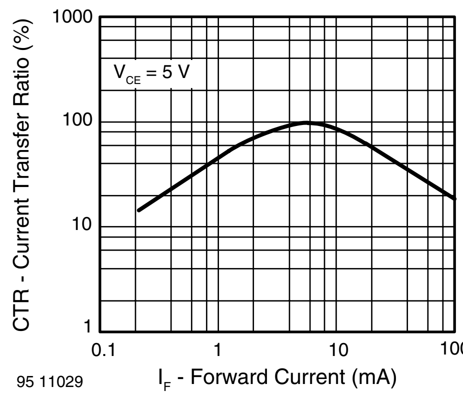


Fig. 14 - Current Transfer Ratio vs. Forward Current

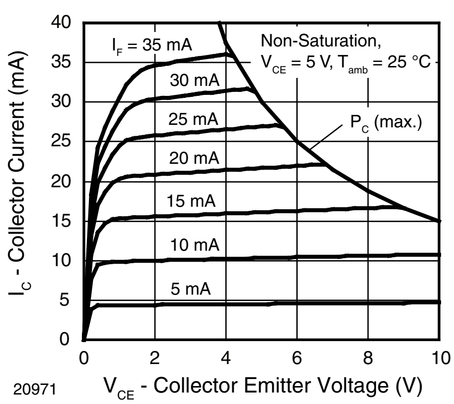


Fig. 12 - Collector Current vs. Collector Emitter Voltage

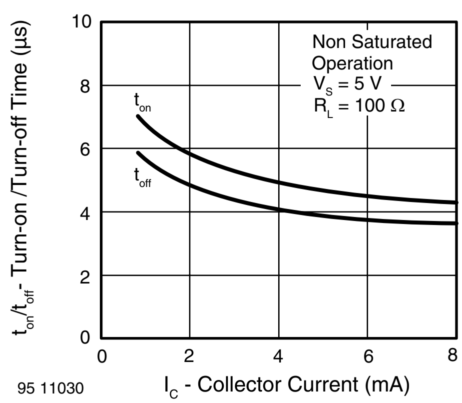


Fig. 15 - Turn-on/off Time vs. Collector Current

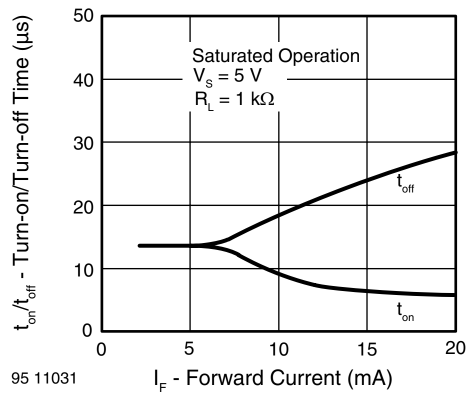
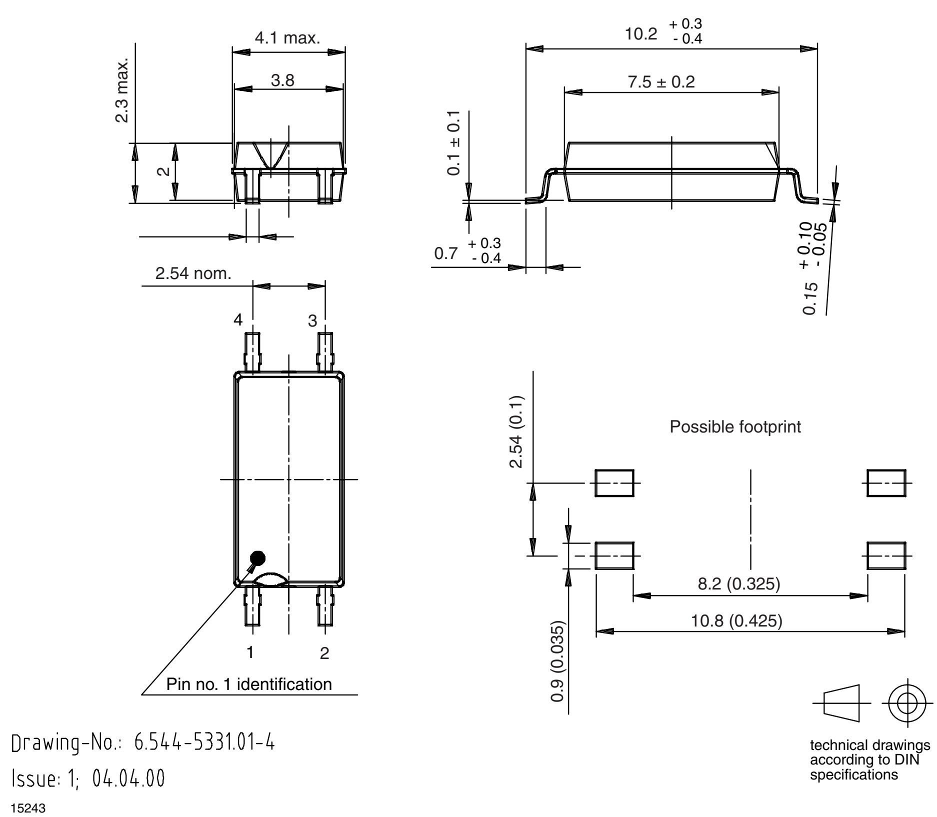


Fig. 16 - Turn-on/off Time vs. Forward Current

PACKAGE DIMENSIONS in millimeters (inches)



OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

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